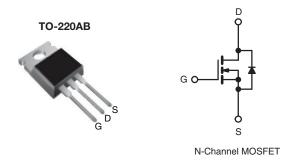
COMPLIANT HALOGEN

**FREE** 

Vishay Siliconix

## **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.6			
Q <sub>g</sub> max. (nC)	48			
Q <sub>gs</sub> (nC)	6			
Q <sub>gd</sub> (nC)	11			
Configuration	Single			



#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

OORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP6N65E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	V	
Gate-Source Voltage			$V_{GS}$	± 30	V	
Continuous Proin Current (T = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		7	А	
Continuous Drain Current (T <sub>J</sub> = 150 °C)		T <sub>C</sub> = 100 °C	I <sub>D</sub>	5		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	18		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	56	mJ	
Maximum Power Dissipation			P <sub>D</sub>	78	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		dV/dt	37	1//20	
Reverse Diode dV/dt <sup>d</sup>			αν/ατ	27	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C		

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 2 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.6	G/ VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Oala Oa and Ladana			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 1	μΑ
Zana Oata Valtana Busin Commant		V <sub>DS</sub> =	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V		-	1	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		10	μA		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 3 A	-	2	-	S
Dynamic		<u> </u>					
Input Capacitance	C <sub>iss</sub>		Voc = 0 V	-	820	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ - 40 -		-			
Reverse Transfer Capacitance	C <sub>rss</sub>	$V_{DS} = 30 \text{ V, } I_{D} = 3 \text{ A} \qquad - \qquad 2 \qquad - \qquad \\ V_{GS} = 0 \text{ V,} \qquad - \qquad 820 \qquad - \qquad \\ V_{DS} = 100 \text{ V,} \qquad - \qquad 40 \qquad - \qquad \\ f = 1 \text{ MHz} \qquad - \qquad 4 \qquad - \qquad \\ V_{DS} = 0 \text{ V to } 520 \text{ V, } V_{GS} = 0 \text{ V} \qquad - \qquad 117 \qquad - \qquad \\ - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad 48 \qquad - \qquad 2 \qquad - \qquad 24 \qquad$		-			
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	pF		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-			
Total Gate Charge	Qg			-	24	48	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A, V_{DS} = 520 V$	-	6	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	1		-	11	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	28	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 3 A,		-	12	24	
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, $R_q = 9.1 \Omega$	-	30	60	ns ns
Fall Time	t <sub>f</sub>	7	v	-	20	40	
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, open drain	-	1.4	-	Ω
<b>Drain-Source Body Diode Characteristic</b>	S						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	bol	-	-	7	
Pulsed Diode Forward Current	I <sub>SM</sub>	Ü	integral reverse p - n junction diode		-	18	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	-	1.3	V
Reverse Recovery Time	t <sub>rr</sub>			-	237	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		15 °C, I <sub>F</sub> = I <sub>S</sub> = 3 A,	-	2.2	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	dI/dt = 100 A/ $\mu$ s, $V_B$ = 25 V		16	_	A	

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

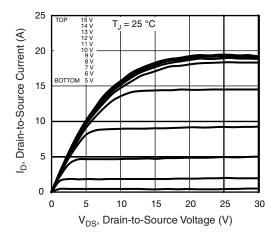


Fig. 1 - Typical Output Characteristics

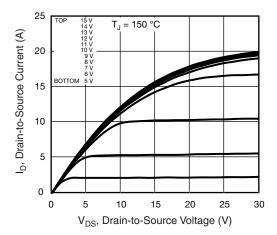


Fig. 2 - Typical Output Characteristics

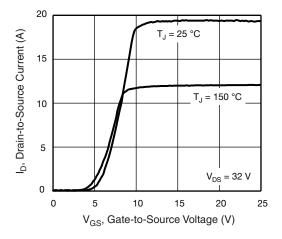


Fig. 3 - Typical Transfer Characteristics

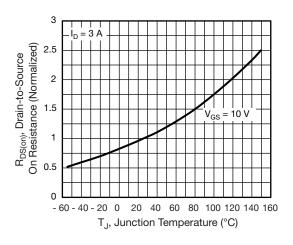


Fig. 4 - Normalized On-Resistance vs. Temperature

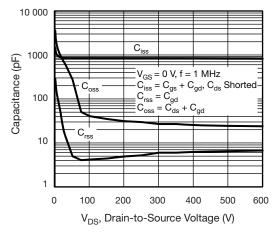


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

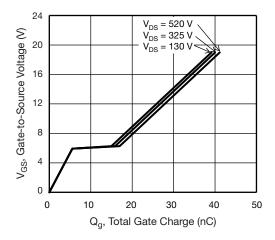


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



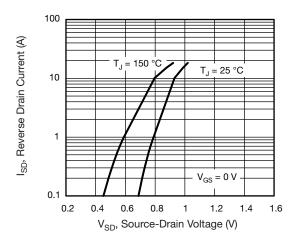


Fig. 7 - Typical Source-Drain Diode Forward Voltage

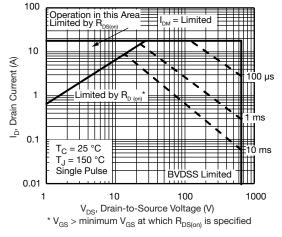


Fig. 8 - Maximum Safe Operating Area

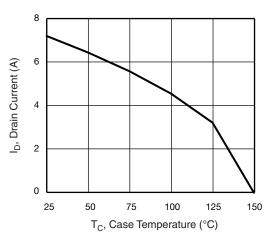


Fig. 9 - Maximum Drain Current vs. Case Temperature

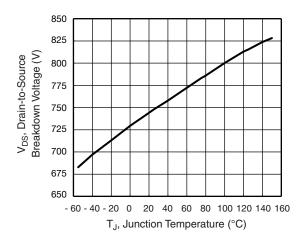


Fig. 10 - Temperature vs. Drain-to-Source Voltage

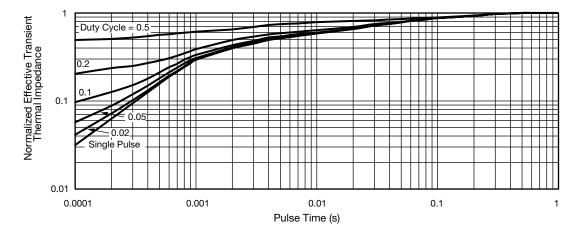


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

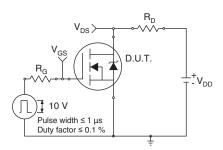


Fig. 12 - Switching Time Test Circuit

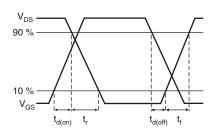


Fig. 13 - Switching Time Waveforms

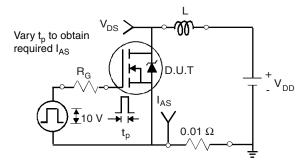


Fig. 14 - Unclamped Inductive Test Circuit

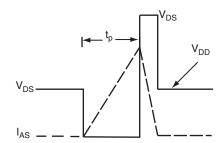


Fig. 15 - Unclamped Inductive Waveforms

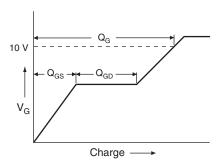


Fig. 16 - Basic Gate Charge Waveform

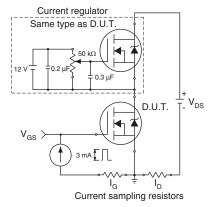
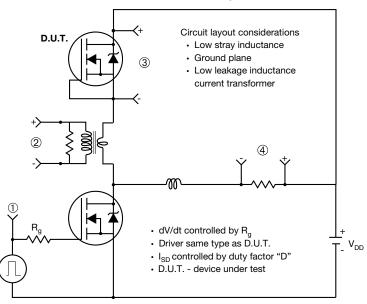


Fig. 17 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



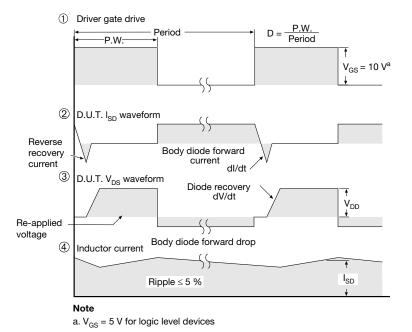


Fig. 18 - For N-Channel

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# TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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Revision: 02-Oct-12 Document Number: 91000

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